PTO/SB/08a (03-08)
Approved for use through 04/30/2008. OMB 0651-0031
formation Disclosure Statement (IDS) Filed
U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE
Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number. Doc code :IDS

Doc description: Information Disclosure Statement (IDS) Filed

INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)	Application Number		10806894	
	Filing Date		2004-03-23	
	First Named Inventor Eoff, e		f, et al.	
	Art Unit		1796	
	Examiner Name Figure		gueroa, John	
	Attorney Docket Numb	er	2001-IP-005267U1P2	

	,			U.S.	PATENTS		
Examiner Initial*	Latent Nillmhar		Kind Code ¹ Issue Date		Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear	
	1						
If you wisl	h to a	dd additional U.S. Paten	ıt citatio	n information p	lease click the Add button.	<u></u>	
			U.S.P	ATENT APPLI	CATION PUBLICATIONS		
Examiner Initial*	Cite No	Publication Number	Kind Code ¹	Publication Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear	
	1	20050194140		2005-09-08	Dalrymple, et al.		
	2	20070012445		2007-01-18	Nguyen, et al.		
	3	20060124309		2006-06-15	Nguyen, et al.		
	4	20060137875		2006-06-29	Dusterhoft, et al.		
	5	20060266522		2006-11-30	Eoff, et al.		

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Not for submission under 37 CFR 1.99)

Application Number		10806894		
Filing Date		2004-03-23		
First Named Inventor	Eoff,	et al.		
Art Unit		1796		
Examiner Name	Figue	eroa, John		
Attorney Docket Number		2001-IP-005267U1P2		

	6	20060283592	2006-12-2		2-21	Sierra, et al.				·
	7	20060240994		2006-10-26		Eoff, et al.				
	8	20060234874		2006-10-19		Eoff, et al.				
	9	20080110624		2008-05-15		Nguyen, et al.				·
If you wis	h to ac	dd additional U.S. Publi	shed Ap	plication	citatio	n information p	lease click the Ado	d butto	on.	
				FOREIG	SN PAT	ENT DOCUM	ENTS			4
Examiner Initial*	Cite No	Foreign Document Number ³	Country Code ²		Kind Code ⁴	Publication Date Name of Patentee or Applicant of cited Document			Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear	T5
	1									
If you wisl	h to ac	ld additional Foreign Pa	atent Do	cument	citation	information pl	ease click the Add	butto	n	
			NON	I-PATEN	NT LITE	RATURE DO	CUMENTS			
Examiner Initials*	Examiner Initials* Cite No Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc), date, pages(s), volume-issue number(s), publisher, city and/or country where published.									T 5
	1	Office Action dated 02/01/08 from Application Serial No. 10/440,337								
2 Office Action dated 05/22/08 from Application Serial No. 11/102,062										

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Not for submission under 37 CFR 1.99)

Application Number		10806894	
Filing Date		2004-03-23	
First Named Inventor	Eoff,	et al.	
Art Unit		1796	
Examiner Name	Figue	roa, John	
Attorney Docket Number		2001-IP-005267U1P2	

	3 U.S. Patent Application No. 12/080,647 filed 04/04/08								
If you wis	If you wish to add additional non-patent literature document citation information please click the Add button								
ii you wio	EXAMINER SIGNATURE								
	EAAMINER SIGNATURE								
Examiner Signature			Date Considered						
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through a citation if not in conformance and not considered. Include copy of this form with next communication to applicant.									
Standard ST	F.3). ³ F cument	or Japa by the a	O Patent Documents at www.uspto.gov or MPEP 901.04. ² Enter office that issued the document anese patent documents, the indication of the year of the reign of the Emperor must precede the sere appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁵ Applican is attached.	ial number of the patent doc	cument.				